



Material Content Data Sheet



Sales Product Name		BTS72220-4ESE		Issued		1. August 2018		
MA#		MA001966298						
Package		PG-TSDSO-24-32		Weight*		113.27 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	3.687	3.25	3.25	32549	32549
leadframe	inorganic material	phosphorus	7723-14-0	0.016	0.01		141	
	non noble metal	zinc	7440-66-6	0.064	0.06		565	
	non noble metal	iron	7439-89-6	1.279	1.13		11291	
wire	non noble metal	copper	7440-50-8	51.928	45.84	47.04	458445	470442
	non noble metal	copper	7440-50-8	1.679	1.48	1.48	14827	14827
	encapsulation	organic material	carbon black	1333-86-4	0.148	0.13		1311
plastics	plastics	epoxy resin	-	5.790	5.11		51117	
		inorganic material	silicondioxide	60676-86-0	43.548	38.45	43.69	384466
leadfinish	non noble metal	tin	7440-31-5	2.781	2.46	2.46	24553	24553
plating	noble metal	silver	7440-22-4	1.324	1.17	1.17	11685	11685
glue	plastics	epoxy resin	-	0.179	0.16		1584	
		noble metal	silver	7440-22-4	0.846	0.75	0.91	7466
*deviation	< 10%					Sum in total:	100.00	1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
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This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

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